

1/2W, 0805 Low Resistance Chip Resistor (Lead / Halogen free)

1. Scope

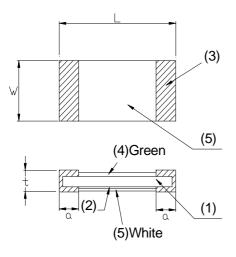
This specification applies to 1.2mm x 2.0mm size 1/2W, fixed metal foil with ceramic carrier current sensing resistors used in electronic equipment.

2. Type Designation

RL1220	— 4 — 🗌	
(1)	(2) (3)	(4)
Where	(1) Series No.	
	(2) Power rating	
	4 = 1/2W	
	(3) Resistance value:	
	For example—	
	$R010 = 0.010 \ \Omega$	
	(4) Resistance tolerance	:
	$F=\pm 1\%$	

 $G = \pm 2\%$ $J = \pm 5\%$

3. Construction and Physical Dimensions



Code Letter	Dimensions (mm)
L	2.00 ± 0.20
W	1.30 ± 0.20
t	0.80 ± 0.25
a	0.40 ± 0.20

NOTE:

(2) Resistor: Cu alloy	
(3) Terminals: Sn (on Cu)	
(4) Marking: Heat resistive epoxy resin(Gree	n)
(5) Protection coat: Heat resistive epoxy resin(Whit	e)

Figure 1. Structure (No mark)



4. Ratings

4-1 Specification

Power Rating*	1/2 W
Resistance Range	10~50(mΩ)
Temperature Coefficient of Resistance	±100ppm/°C
Resistance Tolerance	±1%, ±2%, ±5%

Note*:

Power rating is based on continuous full load operation at rated ambient temperature of 70° C. For resistors operated at ambient temperature in excess of 70° C, the maximum load shall be derated in accordance with the following curve.

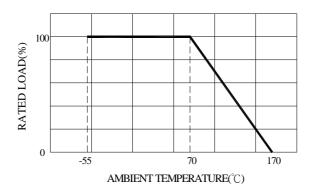


Figure 2. : Power Temperature Derating Curve

4-2 Rated Voltage

The rated voltage shall be determined by the following expression.

 $V = \sqrt{P \times R}$ Where V : Rated voltage (V)

R : Nominal resistance value (Ω)

P: Rated dissipation (W)

4-3 Operating and Storage Temperature Range -55 to +170 $^\circ \text{C}$



Without distinct deformation in

appearance

Test Item	Condition of Test	Requirements
Short Time Overload	2.5 * Rated power for 5 seconds Refer to JIS C 5201-1 4.13	$\Delta R: \pm (0.5\% + 0.0005\Omega)$ Without significant damage by flashover (spark, arching), bur or breakdown etc.
Insulation Resistance		Between Electrode and Protecti Film 100MΩ or over Between Electrode and Substra 1,000MΩ or over
Voltage Proof	The voltage : 100V _{AC} (rms.) for 1 minute Refer to JIS C 5201-1 4.7	$\Delta R : \pm (0.5\% + 0.0005 \Omega)$ Without damage by flashover, f or breakdown, as shown below.
Thermal Shock	-55 ~125℃ 100 cycles, 15 min at each extreme condition Refer to JIS C 5201-1 4.19	$\Delta R : \pm (1.0\% + 0.0005 \Omega)$ Without distinct damage in appearance
Low Temperature Storage	Kept at -55°C, 1,000 hours Refer to JIS C 5201-1 4.23.4	$\Delta R : \pm (1.0\% + 0.0005 \Omega)$ Without distinct damage in appearance
High Temperature Exposure	Kept at 170°C for 1,000 hours Refer to JIS C 5201-1 4.23.2	$\Delta R: \pm (1.0\% + 0.0005 \Omega)$ Without distinct damage in appearance
Solderability	Temperature of Solder : $245 \pm 5^{\circ}$ C Immersion Duration : 2 ± 0.5 second Refer to JIS C 5201-1 4.17	Uniform coating of solder cove minimum of 95% surface being immersed
Resistance to Soldering Heat	Dipped into solder at $270 \pm 5^{\circ}$ C	$\Delta R : \pm (0.5\% + 0.0005\Omega)$

for 10 ± 1 seconds

Refer to JIS C 5201-1 4.18

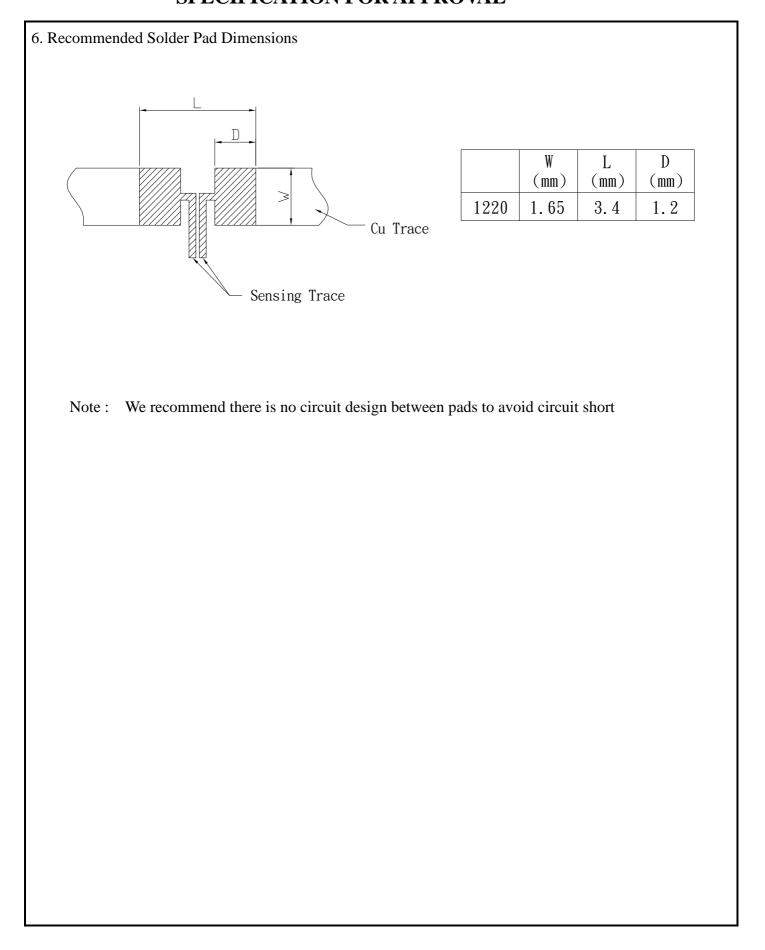


DOCUMENT: SM340000NHREVISION: A2PAGE: 4 OF 7

Test Item	Condition of Test	Requirements
Load Life	Rated voltage for 1.5 hours followed by a pause 0.5 hour at $70 \pm 2^{\circ}$ C. Cycle repeated 1000 hours Refer to JIS C 5201-1 4.25	$\Delta R : \pm (1.0\% + 0.0005 \Omega)$ Without distinct damage in appearance
Damp Heat with Load	$40 \pm 2^{\circ}$ C with relative humidity 90% to 95%. D.C. rated voltage for 1.5 hours ON and 30 minutes OFF. Cycle repeated 1,000 hours Refer to JIS C 5201-1 4.24	$\Delta \mathbf{R} : \pm (1.0\% + 0.0005 \Omega)$ Without distinct damage in appearance
Mechanical Shock	100 G's for 6milliseconds. 5 pulses Refer to JIS C 5201-1 4.21	$\Delta R : \pm (0.5\% + 0.0005\Omega)$ Without mechanical damage such as break
Bending Test	Glass-Epoxy board thickness : 1.6mm Bending width : 2mm Between the fulcrums : 90mm Refer to JIS C 5201-1 4.33	$\Delta R : \pm (0.5\% + 0.0005\Omega)$ Without mechanical damage such as break

SPECIFICATION FOR APPROVAL

DOCUMENT: SM340000NHREVISION: A2PAGE: 5 OF 7



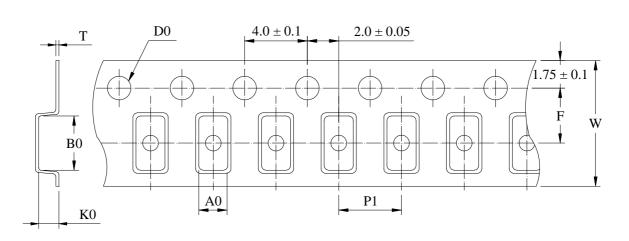


DOCUMENT: SM340000NHREVISION: A2PAGE: 6 OF 7

7. Packaging

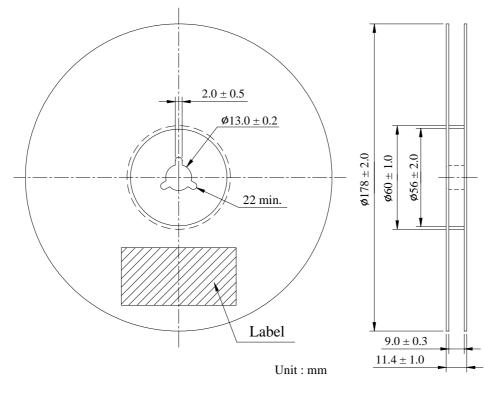
7-1 Dimensions

7-1-1 Tape packaging dimensions



A0	1.65 ± 0.10	F	3.50 ± 0.05
B0	2.35 ± 0.10	P1	4.00 ± 0.10
Т	0.20 ± 0.10	W	8.00 ± 0.30
К0	1.05 ± 0.10	D0	$\phi \ 1.55 \pm 0.05$

7-1-2 Reel Dimensions



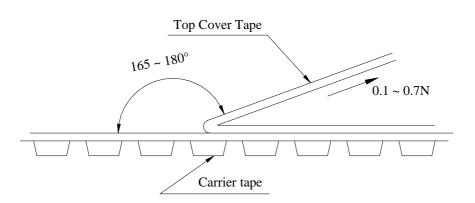
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DOCUMENT: SM340000NHREVISION: A2PAGE: 7 OF 7

7-2 Peel force of top cover tape

The peel speed shall be about 300 mm / min.

The peel force of top cover tape shall be between 0.1 to 0.7 N.



7-3 Numbers of taping

4,000 pieces / reel

7-4 Label marking

The following items shall be marked on the reel.

- (1) Type designation
- (2) Quantity
- (3) Manufacturing date code
- (4) Manufacturer's name
- (5) The country of origin